



RSH40106 Hex inverting Schmitt trigger

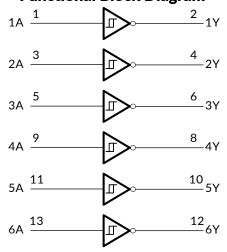
1 FEATURES

- Wide supply voltage range from 3V to 15V
- CMOS low power dissipation
- High noise immunity
- Schmitt trigger input discrimination
- Fully static operation
- 5V,10V and 15V Parametric Ratings
- Standardized symmetrical output characteristics
- Operating Temperature Range: -40°C to +125°C
- Micro SIZE PACKAGES: SOP14, TSSOP14

2 APPLICATIONS

- Wave and Pulse Shapers
- Monostable Multivibrators
- Astable Multivibrators

Functional Block Diagram



3 DESCRIPTIONS

The RSH40106 is a hex inverter with Schmitt-trigger inputs. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of Vcc.

The RSH40106 is available in Green SOP14 and TSSOP14 packages. It operates over an ambient temperature range of -40°C to +125°C.

Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
RSH40106	SOP14	8.65mm×3.90mm
K5H4U1U0	TSSOP14	5.00mm×4.40mm

⁽¹⁾ For all available packages, see the orderable addendum at the end of the data sheet.

4 FUNCTION TABLE

INPUTS	OUTPUT
Α	Υ
Н	L
L	Н

H=High Voltage Level L=Low Voltage Level



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5 Revision HistoryNote: Page numbers for previous revisions may different from page numbers in the current version.

Version	Change Date	Change Item			
A.1	2023/12/13	Initial version completed			
A.1.1	2024/02/29	Modify packaging naming			



6 PACKAGE/ORDERING INFORMATION (1)

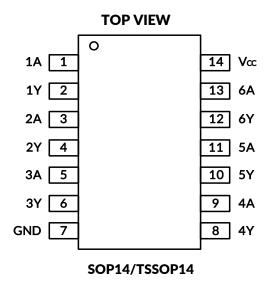
PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING (2)	MSL ⁽³⁾	PACKAGE OPTION
DC1140407	RSH40106XP-G	-40°C ~+125°C	SOP14	RSH40106	MSL1	Tape and Reel,4000
RSH40106	RSH40106XQ-G	-40°C ~+125°C	TSSOP14	RSH40106	MSL1	Tape and Reel,4000

NOTE:

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) MSL, The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications.



7 PIN CONFIGURATIONS



PIN DESCRIPTION

PIN	NAME	I/O TYPE (1)	FUNCTION			
SOP14/TSSOP14	NAME	I/OTTPE **	FUNCTION			
1	1A	I	Input 1			
2	1Y	0	output 1			
3	2A	I	Input 2			
4	2Y	0	output 2			
5	3A	I	Input 3			
6	3Y	0	output 3			
7	GND	Р	Ground			
8	4Y	0	output 4			
9	4A	I	Input 4			
10	5Y	0	output 5			
11	5A	I	Input 5			
12	6Y	0	output 6			
13	6A	I	Input 6			
14	Vcc	Р	Power pin			

⁽¹⁾ I=input, O=output, P=power.



8 SPECIFICATIONS

8.1 Absolute Maximum Ratings (1)

over operating free-air temperature range (unless otherwise noted) (1) (2)

			MIN	MAX	UNIT
V _{CC}	V _{CC} Supply voltage range				V
Vı	Input voltage range ⁽²⁾		-0.5	V _{CC} +0.5	V
Vo	Voltage range applied to any output in the high-impe	edance or power-off state (2)	-0.5	18	V
Vo	Vo Voltage range applied to any output in the high or low state (2) (3)			V _{CC} +0.5	V
lıĸ	Input clamp current V _I <-0.5V			-50	mA
lok	I_{OK} Output clamp current $V_0 < 0$ or $V_0 > V_{CC} + 0.5V$			±50	mA
lo	lo Continuous output current				mA
	Continuous current through V _{CC} or GND			±50	mA
0	Dedicate the word instruction of (4)	SOP14		105	°C/W
Αιθ	Package thermal impedance ⁽⁴⁾	TSSOP14		90	-C/VV
τJ	T _J Junction temperature ⁽⁵⁾			150	°C
T _{stg}	T _{stg} Storage temperature				°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V_{CC} is provided in the Recommended Operating Conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD-51.
- (5) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

8.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

	·	VALUE	UNIT
	Human-body model (HBM), MIL-STD-883K METHOD 3015.9	±2000	V
V _(ESD) Electrostatic discharge	Charged-device model (CDM), ANSI/ESDA/JEDEC JS-002-2018	±1000	V
	Machine model (MM), JESD22-A115C (2010)	±200	V



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



9 ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (TYP values are at T_A = +25°C, Full=-40°C to 125°C, unless otherwise noted.) (1)

9.1 Recommended Operating Conditions

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Supply voltage	V _{CC}		3	15	V
Input voltage	Vı		0	15	V
Output voltage	Vo		0	V _{CC}	٧
Operating temperature	TA		-40	125	°C

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.



9.2 DC Characteristics

over recommended operating free-air temperature range (unless otherwise noted.) (1)

	PARAMETER	TEST CONDITIONS	Vcc	TEMP	MIN ⁽²⁾	TYP ⁽³⁾	MAX ⁽²⁾	UNI
			5V		2.0		3.5	
V_{T^+}	Positive going input threshold voltage		10V	Full	3.7		7.0	٧
	tillesiloid voitage		15V	1	4.9		11.0	
	Negative going		5V		1.5		3.0	
V _T -	input threshold		10V	Full	3.0		6.3	٧
	voltage		15V	1	4.0		10.0	
			5V		0.5			
ΔVτ	Hysteresis (V _{T+} -V _{T-})		10V	Full	0.7			٧
			15V		0.9			
		I _{OH} = -10μA	3V to 15V		Vcc-0.1			
		I _{OH} = -0.36mA		1	4.6			
		I _{OH} = -0.5mA			4.55			
		I _{OH} = -0.64mA	5) (4.5			
		I _{OH} = -1.1mA	5V		4.3			
		I _{OH} = -1.4mA			4.15			
	V_{OH}	I _{OH} = -1.7mA	Full	4			V	
		I _{OH} = -0.9mA		9.55				
	I _{OH} = -1.3mA	10V		9.35				
	I _{OH} = -1.6mA			9.2				
	I _{OH} = -2.4mA			14.45				
		I _{OH} = -3.4mA	15V		14.2			
		I _{OH} = -4.2mA			14			
		I _{OL} = 10μA	3V to 15V				0.1	
		I _{OL} = 0.36mA					0.4	
		I _{OL} = 0.5mA	5V				0.45	
		I _{OL} = 0.64mA					0.5	1
		I _{OL} = 0.9mA					0.45	
	Vol	I _{OL} = 1.3mA	10V	Full			0.65	V
		I _{OL} = 1.6mA					0.8	
		I _{OL} = 2.4mA					0.55	
		I _{OL} = 3.4mA	15V				0.8	
	I _{OL} = 4.2mA						1	
				25°C		±0.1	±1	
l _l	A input	V _I =15V or GND	15V	Full			±2	μΑ
	1			25°C		0.1	1	
	5V	Full			5	μ/		
				25°C		0.5	1	
	Icc	$V_1=V_{CC}$ or GND, $I_0=0A$	10V	Full		1	15	μA
				25°C		1	1.5	
			15V	Full			20	μ/

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

⁽²⁾ Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.



(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.

9.3 AC Characteristics

PARAMETER	SYMBOL	TEST CON	TEST CONDITIONS		MIN ⁽²⁾	TYP ⁽³⁾	MAX ⁽²⁾	UNIT
		V _{CC} =5V, C _L =50pF	V _{CC} =5V, C _L =50pF			21.5	38.7	
Propagation Delay	t_{pd}	V _{CC} =10V, C _L =50p	F	Full		11.2	19.2	ns
		V _{CC} =15V, C _L =50p	F			9.2	15.0	
		V _{CC} =5V, C _L =50pF				19.1	38.4	
LOW to HIGH output transition time	tr	V _{CC} =10V, C _L =50p	V _{CC} =10V, C _L =50pF			9.0	17.2	ns
transition time		V _{CC} =15V, C _L =50p	V _{CC} =15V, C _L =50pF			7.2	13.5	
		V _{CC} =5V, C _L =50pF				19.4	32.3	
HIGH to LOW output transition time	t _f	V _{CC} =10V, C _L =50p	F	Full		9.9	18.2	ns
transition time		V _{CC} =15V, C _L =50p	F			9.0	16.1	
Input Capacitance	Ci	V _{CC} =5V	V _{CC} =5V			4		рF
		V _{CC} =5V				7.5		
Power dissipation capacitance per out	C_{pd}	V _{CC} =10V	f=10MHz	25°C		10		рF
capacitance per out	·	V _{CC} =15V				13		1

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

⁽²⁾ This parameter is ensured by design and/or characterization and is not tested in production.

⁽³⁾ Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.



9.4 TYPICAL PERFORMANCE CHARACTERISTICS

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

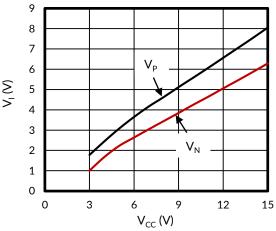


Figure 1. Typical switching levels as a function of supply voltage

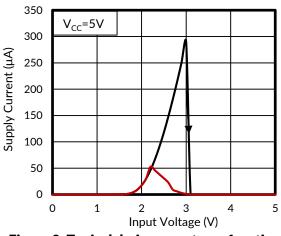


Figure 2. Typical drain current as a function of input

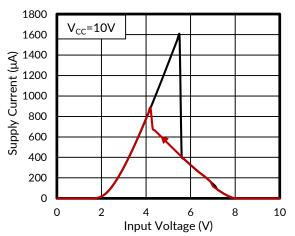


Figure 3. Typical drain current as a function of input

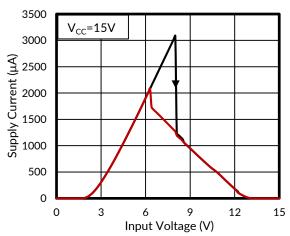
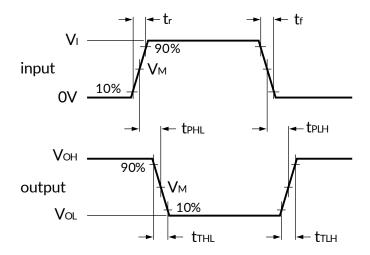


Figure 4. Typical drain current as a function of input



10 Waveforms and test circuit



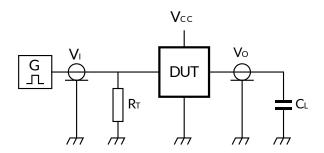
Measurement points are given in Table 1.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load. t_r , t_f = input rise and fall times.

Figure 5. Propagation delay and output transition time

Table 1. Measurement points

Supply voltage	Input	Output
V _{cc}	V_{M}	V _M
5 V to 15 V	0.5 V _{CC}	0.5 V _{CC}



Test data given in Table 2. Definitions for test circuit:

C_L = load capacitance including jig and probe capacitance.

 R_T = termination resistance should be equal to the output impedance Zo of the pulse generator.

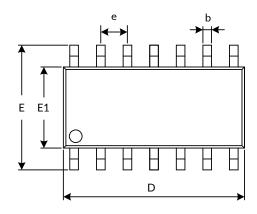
Figure 6. Test circuit for measuring switching times

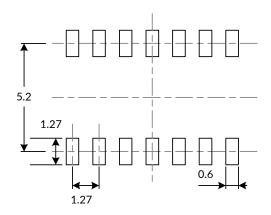
Table 2. Test data

Supply voltage	Inp	Load		
Vcc Vı		t _r , t _f	CL	
5 V to 15 V	Vcc or GND	≤ 20 ns	50 pF	

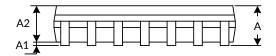


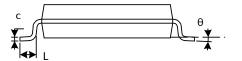
11 PACKAGE OUTLINE DIMENSIONS SOP14 (3)





RECOMMENDED LAND PATTERN (Unit: mm)





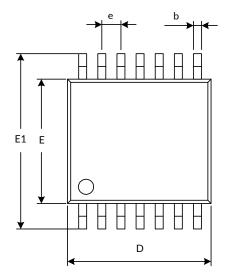
Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Max		
A ⁽¹⁾		1.750		0.069		
A1	0.100	0.100 0.250 1.300 1.500		0.010 0.059		
A2	1.300					
b	0.390	0.470	0.015	0.019		
С	0.200	0.240	0.008	0.009		
D ⁽¹⁾	8.550	8.750	0.336	0.344		
е	1.270(BSC) ⁽²⁾		0.050(BSC) (2)			
E	5.800	6.200	0.228	0.244 0.157		
E1 ⁽¹⁾	3.800	4.000	0.150			
L	0.500	0.800	0.020	0.031 8°		
θ	0°	8°	0°			

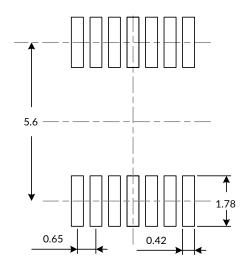
NOTE:

- Plastic or metal protrusions of 0.15mm maximum per side are not included.
 BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
 This drawing is subject to change without notice.

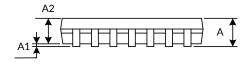


TSSOP14(3)





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Мах		
A ⁽¹⁾		1.200		0.047		
A1	0.050	0.050 0.150 0.002		0.006		
A2	0.900	1.050	0.035	0.041		
b	0.200	0.300	0.008	0.012		
С	0.130	0.170	0.005	0.007 0.201 0.177		
D (1)	4.860	5.100	0.191 0.169			
E ⁽¹⁾	4.300	4.500				
E1	6.200	6.600	0.244	0.260		
е	0.650(BSC) ⁽²⁾		0.026(BSC) (2)			
L	0.450	0.750	0.018	0.030		
Н	0.250(TYP)		0.010(TYP)			
θ	0°	8°	0°	8°		

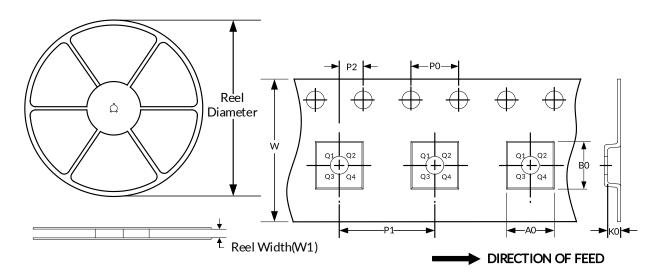
NOTE:

- 1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
- 2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
 3. This drawing is subject to change without notice.



12 TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOP14	13"	16.4	6.60	9.30	2.10	4.0	8.0	2.0	16.0	Q1
TSSOP14	13"	12.4	6.95	5.60	1.20	4.0	8.0	2.0	12.0	Q1

NOTE:

- 1. All dimensions are nominal.
- 2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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